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AMENDMENT TRANSMITTAL LETTER			Docket No. M4065.0374/P374	
Application No. 09/760,741-Conf. #5786	Filing Date January 17, 2001	Examiner C. C. Chu	Art Unit 2815	
Applicant(s): Mike Brooks				
Invention: SEMICONDUCTOR ASSEMBLY WITHOUT ADHESIVE FILLETS				
TO THE COMMISSIONER FOR PATENTS				
Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.				
CLAIMS AS AMENDED				
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate
Total Claims	17	- 39 =	x	0.00
Independent Claims	3	- 7 =	x	0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>				
Other fee (please specify):				
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:				0.00
<input checked="" type="checkbox"/> Large Entity <input type="checkbox"/> Small Entity				
<input checked="" type="checkbox"/> No additional fee is required for this amendment.				
<input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of \$ _____. A duplicate copy of this sheet is enclosed.				
<input type="checkbox"/> A check in the amount of \$ _____ to cover the filing fee is enclosed.				
<input type="checkbox"/> Payment by credit card. Form PTO-2038 is attached.				
<input checked="" type="checkbox"/> The Director is hereby authorized to charge and credit Deposit Account No. <u>04-1073</u> as described below. A duplicate copy of this sheet is enclosed.				
<input checked="" type="checkbox"/> Credit any overpayment.				
<input checked="" type="checkbox"/> Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.				
<div style="text-align: center;"> _____ Thomas J. D'Amico Attorney Reg. No.: 28,371</div>			Dated: <u>June 21, 2004</u>	
DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP 2101 L Street NW Washington, DC 20037-1526 (202) 828-2232				



Docket No.: M4065.0374/P374
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Mike Brooks

Confirmation No.: 5786

Application No.: 09/760,741

Art Unit: 2815

Filed: January 17, 2001

Examiner: C. C. Chu

For: SEMICONDUCTOR ASSEMBLY
WITHOUT ADHESIVE FILLETS

AMENDMENT AFTER FINAL ACTION (37 C.F.R. SECTION 1.116)

MS AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated May 21, 2004 (Paper No. Mail Date 20040511), finally rejecting claims 1, 4-9, 11-21, 41 and 42, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 8 of this paper.